

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	29	stack and ((photoresist or photosensitive) adj layer) and mask with ((small or large) adj feature) and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 09:44
S2	156	(438/68).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:34
S3	1012	(438/113-114).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:34
S4	514	(438/401).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:34
S5	2005	(438/457-460).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:34
S6	654	(438/462).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:34
S7	119	(438/494).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:34
S8	39	(438/498).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:35
S9	1117	(438/504).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:35
S10	387	(438/589).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:35
S11	250	(438/620).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:35

S12	447	(438/667-668).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:35
S13	222	(438/735).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:35
S14	602	(438/977).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:36
S15	76	(257/118).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:36
S16	84	(257/244).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:36
S17	588	(257/618).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:36
S18	2116	(257/622-623).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:37
S19	0	("stackandetchantandetchingnears ubstrateandmask").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/04/14 16:38
S20	592	stack and etchant and (etching near substrate) and mask	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S21	0	S1 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:39
S22	0	S2 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:39

S23	3	S3 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:39
S24	0	S4 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:39
S25	7	S5 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:39
S26	3	S6 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:39
S27	0	S7 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:39
S28	0	S8 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:39
S29	0	S9 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S30	1	S10 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40

S31	0	S11 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S32	2	S12 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S33	1	S13 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S34	6	S14 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S35	0	S15 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S36	0	S16 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S37	3	S17 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S38	7	S18 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40

S39	0	S19 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:40
S40	376	stack and (etching near substrate) and mask adj layer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:43
S41	0	S40 and S2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:41
S42	1	S40 and S3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:42
S43	2	S40 and S4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:42
S44	2	S40 and S5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:42
S45	0	S40 and S6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:42
S46	0	S40 and S7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:42

S47	0	S40 and S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:42
S48	1	S40 and S9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:42
S49	0	S40 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:42
S50	1402	stack and (etching near substrate) and mask	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:43
S51	0	S50 and S2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:43
S52	5	S50 and S3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:43
S53	7	S50 and S4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:43
S54	10	S50 and S5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44

S55	3	S50 and S6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S56	0	S50 and S7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S57	0	S50 and S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S58	2	S50 and S9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S59	2	S50 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S60	4	S50 and S11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S61	3	S50 and S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S62	1	S50 and S13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44

S63	7	S50 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S64	0	S50 and S15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S65	0	S50 and S16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S66	3	S50 and S17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S67	11	S50 and S18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:44
S68	0	S50 and S19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:45
S69	9	S23 or S25	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:46
S70	12	S69 or S26 or S30 or S32	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:47

S71	25	S69 or S26 or S30 or S32 or S33 or S34 or S37 or S38	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:48
S72	48	S71 or S52 or S53 or S54 or S55 or S58 or S59 or S60 or S61 or S63 or S66 or S67 or S69	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/14 16:50